

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT3853693

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
TING-HAO LIN	04/28/2016
CHIAO-CHENG CHANG	04/28/2016
YI-NONG LIN	04/28/2016
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	KINSUS INTERCONNECT TECHNOLOGY CORP.
<b>Street Address:</b>	NO. 1245, JUNGHUA RD., XINWU DIST.
<b>City:</b>	TAOYUAN CITY
<b>State/Country:</b>	TAIWAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15143354
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(206)374-2899
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	206-622-2900
<b>Email:</b>	DPAI@PAILAW.COM
<b>Correspondent Name:</b>	CHAO-CHANG DAVID PAI
<b>Address Line 1:</b>	1001 FOURTH AVENUE, SUITE 3200
<b>Address Line 4:</b>	SEATTLE, WASHINGTON 98154
<b>ATTORNEY DOCKET NUMBER:</b>	CFP-028474
<b>NAME OF SUBMITTER:</b>	CHAO-CHANG DAVID PAI
<b>SIGNATURE:</b>	/Chao-Chang David Pai/
<b>DATE SIGNED:</b>	04/29/2016
<b>Total Attachments: 2</b>	
source=CFP-028474_Assignment#page1.tif	
source=CFP-028474_Assignment#page2.tif	

UNITED STATES PATENT RIGHTS, OR  
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

**ASSIGNMENT**

Application No. \_\_\_\_\_ Filed \_\_\_\_\_

\*\*\**(Given Name FAMILY NAME (ALL CAPS))*\*\*\*

Insert Name(s) of Inventor(s) ⇒ WHEREAS, Ting-Hao LIN; Chiao-Cheng CHANG; Yi-Nong LIN  
(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements  
in:

Insert Title of Invention ⇒ MULTI-LAYER CIRCUIT BOARD

for which an application for Letters Patent of the United States of America has been executed by the  
undersigned (except in the case of a provisional application)

Insert Date of Signing of Appln. ⇒ On April 28, 2016 \_\_\_\_\_; and

Insert Name of Assignee ⇒ WHEREAS, Kinsus Interconnect Technology Corp.

Insert Address of Assignee ⇒ of No. 1245, Junghua Rd., Xinwu Dist., Taoyuan City, Taiwan, R.O.C.

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is  
desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters  
Patent(s) that may be granted therefor in the United States of America and

Check Box if Appropriate ⇒  in any foreign countries.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged,  
the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and  
transfer unto said Assignee the full and exclusive right to the said invention in the United States of  
America, its territories, dependencies and possessions and the entire right, title and interest in and to  
any and all Letters Patent(s) which may be granted therefor in the United States of America, its  
territories, dependencies and possessions, and if the box above is designated, in any and all foreign  
countries; and to any and all divisions, reissues, continuations, conversions and extensions thereof for  
the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any  
continuing, divisional, conversion or reissue applications thereof and also to execute separate  
assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patent(s) resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of PAI PATENT & TRADEMARK LAW FIRM the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date April 28, 2016 Name of Inventor Ting-Hao Lin  
(Signature) Ting-Hao LIN

Date April 28, 2016 Name of Inventor Chiao-Cheng Chang  
(Signature) Chiao-Cheng CHANG

Date April 28, 2016 Name of Inventor Yi-Nong Lin  
(Signature) Yi-Nong LIN

Date \_\_\_\_\_ Name of Inventor \_\_\_\_\_  
(Signature)

Date \_\_\_\_\_ Name of Inventor \_\_\_\_\_  
(Signature)

Date \_\_\_\_\_ Name of Inventor \_\_\_\_\_  
(Signature)